# WIMA FKM 02

# Film and Foil Capacitors with Mixed Dielectric for Pulse Applications in PCM 2.5 mm

# **Special Features**

#### Pulse duty construction

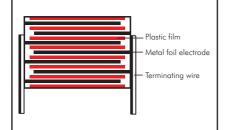
- PCM 2.5 mm
- Constant capacitance value versus temperature (similar to the obsolete Polycarbonate)
- Low dissipation factor
- According to RoHS 2002/95/EC

# **Typical Applications**

For general DC-applications requiring a high capacitance stability versus temperature e.g. Automotive electronics Lighting

# Construction

Dielectric: Mixed film Capacitor electrodes: Metal foil Internal construction:



# **Encapsulation:**

Solvent-resistant, flame-retardent plastic case with epoxy resin seal, UL 94 V-0 **Terminations:** 

# Tinned wire.

# Marking:

Colour: Red. Marking: Gold. Epoxy resin seal: Yellow.

# **Electrical Data**

#### Capacitance range:

1000 pF to 6800 pF (E12-values on request) Rated voltages:

63 VDC, 100 VDC, 250 VDC, 400 VDC **Capacitance tolerances:** 

±20%, ±10%, ±5% Operating temperature range:

-55° C to +100° C Climatic test category:

55/100/21 in accordance with IEC **Insulation resistance** at +20° C:

 $= 5 \times 10^5 MΩ$ (mean value: 1 x 10<sup>6</sup> MΩ) Measuring voltage: U<sub>r</sub> = 63 V: U<sub>test</sub> = 50 V/1 min. U ≥ 100 V/1 min.

# $U_r \ge 100 \text{ V: } U_{test} = 100 \text{ V/1 min.}$ Test voltage: 2 U<sub>r</sub>, 2 sec.

Dissipation factors at +20° C: tan  $\delta$ 

at f	C ≤ 6800 pF
1 kHz 10 kHz 100 kHz	$\leq 3 \times 10^{-3}$ $\leq 5 \times 10^{-3}$ $\leq 8 \times 10^{-3}$

#### Maximum pulse rise time:

1000 V/ $\mu$ sec for pulses equal to the rated voltage

# **Mechanical Tests**

#### Pull test on leads:

10 N in direction of leads according to IEC 60068-2-21

# Vibration:

6 hours at 10 ... 2000 Hz and 0.75 mm displacement amplitude or 10 g in accordance with IEC 60068-2-6

# Low air density:

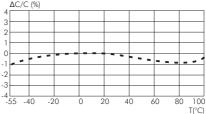
 $1 \mbox{kPa} = 10 \mbox{ mbar}$  in accordance with IEC 60068-2-13

# Bump test:

4000 bumps at 390 m/sec<sup>2</sup> in accordance with IEC 60068-2-29

Capacitance change versus temperature

(f = 1 kHz) (general guide)



# Voltage derating:

A voltage derating factor of 1.35 % per K must be applied from +85° C for DC voltages and from +75° C for AC voltages.

# **Reliability:**

Operational life > 300 000 hours Failure rate < 5 fit (0.5 x U\_r and 40° C)

# Packing

Available taped and reeled.

Detailed taping information and graphs at the end of the catalogue.

For further details and graphs please refer to Technical Information.



# WIMA FKM 02

# Continuation



# **General Data**

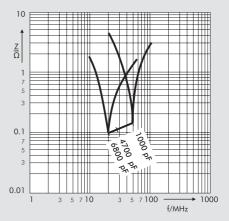
Capacitance	63 VDC/40 VAC*			100 VDC/63 VAC*			250 VDC/160 VAC*			400 VDC/200 VAC*						
Capacitatice	W	Н	L	PCM**	W	Н	L	PCM**	W	Н	L	PCM**	W	H	L	PCM**
1000 pF	2.5	7	4.6	2.5	2.5	7	4.6	2.5	2.5	7	4.6	2.5	3	7.5	4.6	2.5
1500 "	3	7.5	4.6	2.5	3	7.5	4.6	2.5	3	7.5	4.6	2.5	3.8	8.5	4.6	2.5
2200 "	3.8	8.5	4.6	2.5	3.8	8.5	4.6	2.5	3.8	8.5	4.6	2.5	4.6	9	4.6	2.5
3300 "	3.8	8.5	4.6	2.5	4.6	9	4.6	2.5	4.6	9	4.6	2.5	5.5	10	4.6	2.5
4700 "	4.6	9	4.6	2.5	5.5	10	4.6	2.5	5.5	10	4.6	2.5				
6800 "	5.5	10	4.6	2.5	5.5	10	4.6	2.5								

\* AC voltage: f  $\leq$  400 Hz; 1.4 x U\_{rms} + UDC  $\leq$  U\_r

\*\* PCM = Printed circuit module = lead spacing

Dims. in mm.

Taped version see page 104.



Impedance change with frequency (general guide).

 $d = 0.4 \phi$ 

 $\begin{array}{c} \text{PCM} \\ \text{at the lead exit points} \\ (\pm \ 0.5) \end{array}$ 

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# **Recommendation for Processing** and Application of **Through-Hole Capacitors**

#### **Soldering Process**

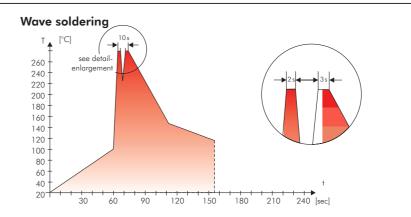
A preheating of through-hole WIMA capacitors is allowed for temperatures T<sub>max</sub> < 100 ° C. In practice a preheating duration of t < 5 min. has been proven to be best.

#### Single wave soldering

Soldering bath temperature:  $T < 260 \circ C$ Immersion time: t < 5 sec

#### Double wave soldering

Soldering bath temperature:  $T < 260 \,^{\circ}$  C Immersion time:  $2 \times t < 3 \sec \theta$ 



Temperature/time graph for the maximum permissible solder bath temperature for the wave soldering of through-hole WIMA capacitors

- PBB/PBDE

- Arsenic

- Mercury

- etc.

# •WIMA Quality and Environmental Philosophy•

### ISO 9001:2000 Certification

ISO 9001:2000 is an international basic standard of quality assurance systems for all branches of industry. The approval according to ISO 9001:2000 of our factories by the VDE inspectorate certifies that organisation, equipment and monitoring of quality assurance in our factories correspond to internationally recognized standards.

# WIMA WPCS

The WIMA Process Control System (WPCS) is a quality surveillance and optimization system developed by WIMA. WPCS is a major part of the quality-oriented WIMA production. Points of application of WPCS during production process:

- incoming material inspection
- metallization
- film inspection
- schoopage
- pre-healing lead attachment
- cast resin preparation/ encapsulation
- 100% final inspection
- AQL check

### **WIMA Environmental Policy**

All WIMA capacitors, irrespective of whether through-hole devices or SMD, are made of environmentally friendly materials. Neither during manufacture nor in the product itself any toxic substances are used, e.g.

- Lead

- PCB
- CFC
- Hvdrocarbon chloride
- Chromium 6+

We merely use pure, recyclable materials for packing our components, such as:

- carton
- cardboard
- adhesive tape made of paper
- polystyrene

We almost completely refrain from using packing materials such as:

- foamed polystyrene (Styropor®)
- adhesive tapes made of plastic
- metal clips

### **RoHS** Compliance

According to the RoHS Directive 2002/95/EC certain hazardous substances like e.g. lead, cadmium, mercury must not be used any longer in electronic equipment as of July 1st, 2006. For the sake of the environment WIMA has refraind from using such substances since years already.



Tape for lead-free WIMA capacitors

# **DIN EN ISO 14001:2005**

WIMA's environmental management has been established in accordance with the auidelines of DIN EN ISO 14001:2005. The certification has been granted in June 2006.



# Typical Dimensions for Taping Configuration

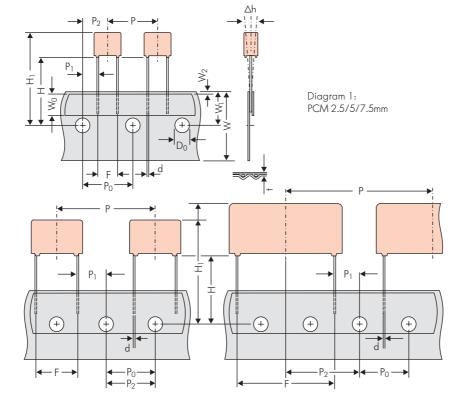


Diagram 2: PCM 10/15 mm

Diagram 3: PCM 22.5 and 27.5\*mm \*PCM 27.5 taping possible with two feed holes between components

		Dimensions for Radial Taping									
Designation	Symbol	PCM 2.5 taping	PCM 5 taping	PCM 7.5 taping	PCM 10 taping*	PCM 15 taping*	PCM 22.5 taping	PCM 27.5 taping			
Carrier tape width	W	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5			
Hold-down tape width	W <sub>0</sub>	6.0 for hot-sealing adhesive tape	6.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape			
Hole position	W <sub>1</sub>	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5			
Hold-down tape position	W <sub>2</sub>	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.			
Feed hole diameter	D <sub>0</sub>	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2			
Pitch of component	Р	12.7 ±1.0	12.7 ±1.0	12.7 ±1.0	25.4 ±1.0	25.4 ±1.0	38.1 ±1.5	38.1 ±1.5 or 50.8 ±1.5			
Feed hole pitch	Po	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	cumulative pitcl 12.7 ±0.3 error max. 1.0 mm/20 pitc			
Feed hole centre to lead	P <sub>1</sub>	5.1 ±0.5	3.85 ±0.7	2.6 ±0.7	7.7 ±0.7	5.2 ±0.7	7.8 ±0.7	5.3 ±0.7			
Hole centre to component centre	P <sub>2</sub>	6.35 ±1.3	6.35 ±1.3	6.35 ±1.3	12.7 ±1.3	12.7 ±1.3	19.05 ±1.3	19.05 ±1.3			
Feed hole centre to bottom	Н▲	16.5 ±0.3	16.5 ±0.3	16.5 ±0.5	16.5 ±0.5	16.5 ±0.5	16.5 ±0.5	16.5 ±0.5			
edge of the component		18.5 ±0.5	18.5 ±0.5	18.5 ±0.5	18.5 ±0.5	18.5 ±0.5	18.5 ±0.5	18.5 ±0.5			
Feed hole centre to top edge of the component	H <sub>1</sub>	H+H <sub>component</sub> < H <sub>1</sub> 32.25 max.	H+H <sub>component</sub> < H <sub>1</sub> 32.25 max.	H+H <sub>component</sub> < H <sub>1</sub> 24.5 to 31.5	H+H <sub>component</sub> < H <sub>1</sub> 25.0 to 31.5	H+H <sub>component</sub> < H <sub>1</sub> 26.0 to 37.0	H+H <sub>component</sub> < H <sub>1</sub> 30.0 to 43.0	H+H <sub>component</sub> < H <sub>1</sub> 35.0 to 45.0			
Lead spacing at upper edge of carrier tape	F	2.5 ±0.5	5.0 <sup>+0.8</sup> <sub>-0.2</sub>	7.5 ±0.8	10.0 ±0.8	15 ±0.8	22.5 ±0.8	27.5 ±0.8			
Lead diameter	diameter d 0.4 ±		0.5 ±0.05	$^{\circ}0.5 \pm 0.05 \text{ or } 0.6 + 0.06 \\ -0.05 $	$^{\circ}0.5 \pm 0.05 \text{ or } 0.6 + 0.06 - 0.05$	0.8 +0,08	0.8 +0,08	0.8 +0.08 -0.05			
Component alignment	ment Δh ± 2.0 max. ± 2.0 max.		± 2.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.			
Total tape thickness	t	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2			
			AMMO	AMMO							
Package (see also page 105)	•	REEL Ø 360 max. Ø 30 ±1	$\left. B \begin{array}{c} 52 \pm 2 \\ 58 \pm 2 \end{array}  ight\}  depending on \ comp. dimensions$		REEL \$\overline{\phi}\$ 360 max. B 52 \pm 2 \overline{\phi}\$ 58 \pm 2 \overline{\phi}\$ 66 \pm 2 \overline{\pm}\$ 40 max. B 58 \pm 2 \overline{\pm}\$ 66 \pm 2 \overline{\pm}\$ 10 max. B 58 \pm 2 \	or REEL Ø 500 max. 54 Ø 25 ±1 860 68	±2 on PCM and				
Unit					see details page 107.						

 $\blacktriangle$  Please give "H" dimensions and desired packaging type when ordering.

• Diameter of leads see General Data.

PCM 10 and PCM 15 can be crimped to PCM 7.5. Position of components according to PCM 7.5 (sketch 1).  $P_0 = 12.7$  or 15.0 is possible

Please clarify customer-specific deviations with the manufacturer.

Dims in mm.